## MC74LCX245

## Low-Voltage CMOS Octal Transceiver

## With 5 V-Tolerant Inputs and Outputs (3-State, Non-Inverting)

The MC74LCX245 is a high performance, non-inverting octal transceiver operating from a 2.0 to 5.5 V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A $\mathrm{V}_{\mathrm{I}}$ specification of 5.5 V allows MC74LCX245 inputs to be safely driven from 5 V devices if $\mathrm{V}_{\mathrm{CC}}$ is less than 5.0 V . The MC74LCX245 is suitable for memory address driving and all TTL level bus oriented transceiver applications.

Current drive capability is 24 mA at both A and B ports. The Transmit/Receive ( $\mathrm{T} / \overline{\mathrm{R}}$ ) input determines the direction of data flow through the bi-directional transceiver. Transmit (active-HIGH) enables data from A ports to B ports; Receive (active-LOW) enables data from B to A ports. The Output Enable input, when HIGH, disables both A and B ports by placing them in a HIGH Z condition.

## Features

- Designed for 2.0 to $5.5 \mathrm{~V} \mathrm{~V}_{\mathrm{CC}}$ Operation
- 5 V Tolerant - Interface Capability With 5 V TTL Logic
- Supports Live Insertion and Withdrawal
- $\mathrm{I}_{\mathrm{OFF}}$ Specification Guarantees High Impedance When $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$
- LVTTL Compatible
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current in All Three Logic States (10 $\mu \mathrm{A}$ ) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500 mA
- ESD Performance: Human Body Model >2000 V Machine Model >200 V
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are $\mathrm{Pb}-$ Free, Halogen Free/BFR Free and are RoHS Compliant


[^0]

Figure 1. Pinout (Top View)

PIN NAMES

| PINS | FUNCTION |
| :--- | :--- |
| $\overline{O E}$ | Output Enable Input |
| T/R | Transmit/Receive Input |
| AO-A7 | Side A 3-State Inputs or 3-State Outputs |
| B0-B7 | Side B 3-State Inputs or 3-StateOutputs |

TRUTH TABLE

| INPUTS |  | OPERATING MODE <br> Non-Inverting |
| :---: | :---: | :---: |
| OE | $\mathrm{T} / \mathrm{R}$ |  |
| L | L | A Data to B Bus |
| L | H | Z |
| $H$ | X |  |

H = High Voltage Level
L = Low Voltage Level
Z = High Impedance State
X = High or Low Voltage Level and Transitions are Acceptable For ICC reasons, Do Not Float Inputs


Figure 2. Logic Diagram

MAXIMUM RATINGS

| Symbol | Parameter | Value | Condition | Unit |
| :--- | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | DC Supply Voltage | -0.5 to +7.0 |  | V |
| $\mathrm{~V}_{\mathrm{I}}$ | DC Input Voltage | $-0.5 \leq \mathrm{V}_{1} \leq+7.0$ |  | V |
| $\mathrm{~V}_{\mathrm{O}}$ | DC Output Voltage | $-0.5 \leq \mathrm{V}_{\mathrm{O}} \leq+7.0$ | Output in 3-State | V |
|  |  | $-0.5 \leq \mathrm{V}_{\mathrm{O}} \leq \mathrm{V}_{\mathrm{CC}}+0.5$ | Output in HIGH or LOW State (Note 1$)$ | V |
| $\mathrm{I}_{\mathrm{IK}}$ | DC Input Diode Current | -50 | $\mathrm{~V}_{1}<\mathrm{GND}$ | mA |
| $\mathrm{I}_{\mathrm{OK}}$ | DC Output Diode Current | -50 | $\mathrm{~V}_{\mathrm{O}}<\mathrm{GND}$ | mA |
|  |  | +50 | $\mathrm{~V}_{\mathrm{O}}>\mathrm{V}_{\mathrm{CC}}$ | mA |
| $\mathrm{I}_{\mathrm{O}}$ | DC Output Source/Sink Current | $\pm 50$ |  | mA |
| $\mathrm{I}_{\mathrm{CC}}$ | DC Supply Current Per Supply Pin | $\pm 100$ | mA |  |
| $\mathrm{I}_{\mathrm{GND}}$ | DC Ground Current Per Ground Pin | $\pm 100$ | mA |  |
| $\mathrm{~T}_{\text {STG }}$ | Storage Temperature Range | -65 to +150 |  | ${ }^{\circ} \mathrm{C}$ |
| MSL | Moisture Sensitivity |  | Level 1 |  |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. $I_{0}$ absolute maximum rating must be observed.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {cc }}$ | Supply VoltageOperating <br> Data Retention Only | $\begin{aligned} & 2.0 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 2.5,3.3 \\ & 2.5,3.3 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 55 \end{aligned}$ | V |
| $V_{1}$ | Input Voltage | 0 |  | 5.5 | V |
| $\mathrm{V}_{\mathrm{O}}$ | Output Voltage <br> (HIGH or LOW State) <br> (3-State) | $\begin{aligned} & 0 \\ & 0 \end{aligned}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}} \\ 5.5 \end{gathered}$ | V |
| ${ }^{\text {OH }}$ | HIGH Level Output Current $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}-3.6 \mathrm{~V}$ <br>  $\mathrm{~V}_{\mathrm{CC}}=2.7 \mathrm{~V}-3.0 \mathrm{~V}$ <br>  $\mathrm{~V}_{\mathrm{CC}}=2.3 \mathrm{~V}-2.7 \mathrm{~V}$ |  |  | $\begin{gathered} -24 \\ -12 \\ -8 \end{gathered}$ | mA |
| ${ }_{\mathrm{OL}}$ | LOW Level Output Current $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}-3.6 \mathrm{~V}$ <br>  $\mathrm{~V}_{\mathrm{CC}}=2.7 \mathrm{~V}-3.0 \mathrm{~V}$ <br>  $\mathrm{~V}_{\mathrm{CC}}=2.3 \mathrm{~V}-2.7 \mathrm{~V}$ |  |  | $\begin{gathered} +24 \\ +12 \\ +8 \end{gathered}$ | mA |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Free-Air Temperature | -55 |  | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\Delta t / \Delta \mathrm{V}$ | Input Transition Rise or Fall Rate, $\mathrm{V}_{\text {IN }}$ from 0.8 V to $2.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ | 0 |  | 10 | $\mathrm{ns} / \mathrm{V}$ |

DC ELECTRICAL CHARACTERISTICS

| Symbol | Characteristic | Condition | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH Level Input Voltage (Note 2) | $2.3 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CC}} \leq 2.7 \mathrm{~V}$ | 1.7 |  | V |
|  |  | $2.7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CC}} \leq 3.6 \mathrm{~V}$ | 2.0 |  |  |
| $\mathrm{V}_{\text {IL }}$ | LOW Level Input Voltage (Note 2) | $2.3 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CC}} \leq 2.7 \mathrm{~V}$ |  | 0.7 | V |
|  |  | $2.7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CC}} \leq 3.6 \mathrm{~V}$ |  | 0.8 |  |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH Level Output Voltage | $2.3 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CC}} \leq 3.6 \mathrm{~V}$; $\mathrm{I}_{\mathrm{OL}}=100 \mu \mathrm{~A}$ | $\mathrm{V}_{\text {CC }}-0.2$ |  | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V} ; \mathrm{I}_{\mathrm{OH}}=-8 \mathrm{~mA}$ | 1.8 |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V} ; \mathrm{I}_{\mathrm{OH}}=-12 \mathrm{~mA}$ | 2.2 |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V} ; \mathrm{I}_{\mathrm{OH}}=-18 \mathrm{~mA}$ | 2.4 |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V} ; \mathrm{I}_{\mathrm{OH}}=-24 \mathrm{~mA}$ | 2.2 |  |  |
| $\mathrm{V}_{\mathrm{OL}}$ | LOW Level Output Voltage | $2.3 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CC}} \leq 3.6 \mathrm{~V}$; $\mathrm{l}_{\mathrm{OL}}=100 \mu \mathrm{~A}$ |  | 0.2 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.3 \mathrm{~V}$; $\mathrm{l}_{\mathrm{OL}}=8 \mathrm{~mA}$ |  | 0.6 |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$; $\mathrm{l}_{\mathrm{OL}}=12 \mathrm{~mA}$ |  | 0.4 |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$; $\mathrm{IOL}=16 \mathrm{~mA}$ |  | 0.4 |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$; $\mathrm{IOL}=24 \mathrm{~mA}$ |  | 0.55 |  |
| $\mathrm{I}_{\mathrm{OZ}}$ | 3-State Output Current | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}}, \\ \mathrm{~V}_{\text {OUT }}=0 \text { to } 5.5 \mathrm{~V} \end{gathered}$ |  | $\pm 5$ | $\mu \mathrm{A}$ |
| IOFF | Power Off Leakage Current | $\mathrm{V}_{\text {CC }}=0, \mathrm{~V}_{\text {IN }}=5.5 \mathrm{~V}$ or $\mathrm{V}_{\text {OUT }}=5.5 \mathrm{~V}$ |  | 10 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{IN}}$ | Input Leakage Current | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=5.5 \mathrm{~V}$ or GND |  | $\pm 5$ | $\mu \mathrm{A}$ |
| ICc | Quiescent Supply Current | $\mathrm{V}_{\mathrm{CC}}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=5.5 \mathrm{~V}$ or GND |  | 10 | $\mu \mathrm{A}$ |
| $\Delta \mathrm{l}_{\text {CC }}$ | Increase in $\mathrm{I}_{\text {CC }}$ per Input | $2.3 \leq \mathrm{V}_{\mathrm{CC}} \leq 3.6 \mathrm{~V}$; $\mathrm{V}_{\mathrm{IH}}=\mathrm{V}_{\mathrm{CC}}-0.6 \mathrm{~V}$ |  | 500 | $\mu \mathrm{A}$ |

2. These values of $\mathrm{V}_{\mathrm{I}}$ are used to test DC electrical characteristics only.

AC CHARACTERISTICS $\mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=2.5 \mathrm{~ns} ; \mathrm{R}_{\mathrm{L}}=500 \Omega$

| Symbol | Parameter | Waveform | Limits |  |  |  |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |  |
|  |  |  | $\mathrm{V}_{\mathrm{Cc}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ |  | $\mathrm{V}_{\mathrm{cc}}=2.5 \mathrm{~V} \pm 0.2 \mathrm{~V}$ |  | $\mathrm{V}_{\mathrm{cc}}=5.0 \mathrm{~V}$ |  |  |
|  |  |  | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |  | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |  | $\mathrm{C}_{\mathrm{L}}=30 \mathrm{pF}$ |  | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |  |  |
|  |  |  | Min | Max | Min | Max | Min | Max | Min | Max |  |
| $\begin{aligned} & \text { tpLH } \\ & t_{\text {PHL }} \end{aligned}$ | Propagation Delay Input to Output | 1 | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 7.0 \\ & 7.0 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 8.0 \\ & 8.0 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 8.4 \\ & 8.4 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 5.0 \\ & 5.0 \end{aligned}$ | ns |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{pzH}} \\ & \mathrm{t}_{\text {PZL }} \end{aligned}$ | Output Enable Time to High and Low Level | 2 | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 8.5 \\ & 8.5 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 9.5 \\ & 9.5 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & \hline 10.5 \\ & 10.5 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 7.0 \\ & 7.0 \end{aligned}$ | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{PHZ}} \\ & \mathrm{t}_{\mathrm{PLZ}} \\ & \hline \end{aligned}$ | Output Disable Time From High and Low Level | 2 | $\begin{aligned} & \hline 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 7.5 \\ & 7.5 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 8.5 \\ & 8.5 \end{aligned}$ | $\begin{aligned} & \hline 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & \hline 9.0 \\ & 9.0 \end{aligned}$ | $\begin{aligned} & 1.5 \\ & 1.5 \end{aligned}$ | $\begin{aligned} & 6.0 \\ & 6.0 \end{aligned}$ | ns |
| toshl tosLh | Output-to-Output Skew (Note 3) |  |  | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ |  | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ |  | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ |  | $\begin{aligned} & 1.0 \\ & 1.0 \\ & \hline \end{aligned}$ | ns |

3. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (toshl) or LOW-to-HIGH (tosLH); parameter guaranteed by design.

DYNAMIC SWITCHING CHARACTERISTICS

| Symbol | Characteristic | Condition | $\mathrm{T}_{\text {A }}=+25^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |
| Volp | Dynamic LOW Peak Voltage (Note 4) | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{~V}_{\mathrm{IH}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CC}}=2.5 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=30 \mathrm{pF}, \mathrm{~V}_{\mathrm{IH}}=2.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & 0.8 \\ & 0.6 \end{aligned}$ |  | V |
| V OLV | Dynamic LOW Valley Voltage (Note 4) | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{~V}_{\mathrm{IH}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{CC}}=2.5 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=30 \mathrm{pF}, \mathrm{~V}_{\mathrm{IH}}=2.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{IL}}=0 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & \hline-0.8 \\ & -0.6 \end{aligned}$ |  | V |

4. Number of outputs defined as " $n$ ". Measured with " $n-1$ " outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

CAPACITIVE CHARACTERISTICS

| Symbol | Parameter | Condition | Typical | Unit |
| :--- | :--- | :---: | :---: | :---: |
| $\mathrm{C}_{\mathrm{IN}}$ | Input Capacitance | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CC}}$ | 7 | pF |
| $\mathrm{C}_{\mathrm{I} / \mathrm{O}}$ | Input/Output Capacitance | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CC}}$ | 8 | pF |
| $\mathrm{C}_{\mathrm{PD}}$ | Power Dissipation Capacitance | $10 \mathrm{MHz}, \mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CC}}$ | 25 | pF |



WAVEFORM 1 - PROPAGATION DELAYS
$t_{R}=t_{F}=2.5 \mathrm{~ns}, 10 \%$ to $90 \% ; f=1 \mathrm{MHz} ; \mathrm{t}_{\mathrm{w}}=500 \mathrm{~ns}$

Figure 3. AC Waveforms

| Symbol | $\mathrm{V}_{\mathrm{CC}}$ |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | $3.3 \mathrm{~V} \pm \mathbf{0 . 3} \mathrm{V}$ | $\mathbf{2 . 7} \mathrm{V}$ | $\mathbf{2 . 5} \mathrm{V} \pm \mathbf{0 . 2} \mathrm{V}$ | $\mathbf{5 . 0} \mathrm{V}$ |
|  | 1.5 V | 1.5 V | $\mathrm{~V}_{\mathrm{Cc}} / 2$ | $\mathrm{~V}_{\mathrm{Cc}} / 2$ |
| Vmo | 1.5 V | 1.5 V | $\mathrm{~V}_{\mathrm{Cc}} / 2$ | $\mathrm{~V}_{\mathrm{Cc}} / 2$ |
| $\mathrm{~V}_{\mathrm{HZ}}$ | $\mathrm{V}_{\mathrm{OL}}+0.3 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OL}}+0.3 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OL}}+0.15 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OL}}+0.15 \mathrm{~V}$ |
| $\mathrm{~V}_{\mathrm{LZ}}$ | $\mathrm{V}_{\mathrm{OH}}-0.3 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OH}}-0.3 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OH}}-0.15 \mathrm{~V}$ | $\mathrm{~V}_{\mathrm{OH}}-0.15 \mathrm{~V}$ |

## MC74LCX245



| TEST | SWITCH |
| :---: | :---: |
| $\mathrm{t}_{\text {PLH, }}$, $\mathrm{t}_{\text {PHL }}$ | Open |
| $\mathrm{t}_{\text {PZL }}, \mathrm{t}_{\text {PLZ }}$ | $\begin{aligned} & 6 \mathrm{~V} \text { at } \mathrm{V}_{\mathrm{CC}}=3.3 \pm 0.3 \mathrm{~V} \\ & 6 \mathrm{~V} \text { at } \mathrm{V}_{\mathrm{CC}}=2.5 \pm 0.2 \mathrm{~V} \end{aligned}$ |
| Open Collector/Drain $\mathrm{tPLH}^{\text {and }} \mathrm{tPHL}$ | 6 V |
| tezh, $^{\text {t }}$ PHZ | GND |

$\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ at $\mathrm{V}_{\mathrm{CC}}=3.3 \pm 0.3 \mathrm{~V}$ or equivalent (includes jig and probe capacitance)
$\mathrm{C}_{\mathrm{L}}=30 \mathrm{pF}$ at $\mathrm{V}_{\mathrm{CC}}=2.5 \pm 0.2 \mathrm{~V}$ or equivalent (includes jig and probe capacitance)
$R_{L}=R_{1}=500 \Omega$ or equivalent
$\mathrm{R}_{\mathrm{T}}=\mathrm{Z}_{\mathrm{OUT}}$ of pulse generator (typically $50 \Omega$ )

Figure 4. Test Circuit

ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :--- | :---: | :---: |
| MC74LCX245DWR2G | SOIC-20 <br> (Pb-Free) | 1000 Tape \& Reel |
| MC74LCX245DWG | SOIC-20 <br> (Pb-Free) | 38 Units / Rail |
| MC74LCX245DTG | TSSOP-20 <br> (Pb-Free) | 75 Units / Rail |
| MC74LCX245DTR2G | TSSOP-20 <br> (Pb-Free) | 2500 Tape \& Reel |
| NLV74LCX245DTR2G* | TSSOP-20 <br> (Pb-Free) | 2500 Tape \& Reel |
| MC74LCX245MNTWG | QFN20 <br> (Pb-Free) | 3000 Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

QFN20, 2.5x4.5 MM
CASE 485AA-01
ISSUE B
DATE 30 APR 2010

## SCALE 2:1



NOTES:
. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSIONS b APPLIES TO PLATED

TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| DIM | MILLIMETERS |  |
| :---: | :---: | :---: |
|  | MIN | MAX |
| A | 0.80 | 1.00 |
| A1 | 0.00 | 0.05 |
| A3 | 0.20 REF |  |
| b | 0.20 | 0.30 |
| D | 2.50 BSC |  |
| D2 | 0.85 | 1.15 |
| E | 4.50 BSC |  |
| E2 | 2.85 | 3.15 |
| e | 0.50 BSC |  |
| K | 0.20 | --- |
| L | 0.35 | 0.45 |

## GENERIC MARKING

 DIAGRAM*| 0 |
| :---: |
| $X X X X$ |
| $X X X X$ |
| ALYW |
| $\bullet$ |


| XXXX | $=$ Specific Device Code |
| :--- | :--- |
| A | $=$ Assembly Location |
| L | = Wafer Lot |
| Y | = Year |
| W | = Work Week |
| - | = Pb-Free Package |

(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " $\quad$ ", may or may not be present.

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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | QFN20. 2.5X4.5 MM | PAGE 1 OF 1 |

[^1]

SCALE 1：1


| Q | 0.25 （M） | T | A（S） | B（S） |
| :--- | :--- | :--- | :--- | :--- |



RECOMMENDED SOLDERING FOOTPRINT＊

＊For additional information on our Pb －Free strategy and soldering details，please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual，SOLDERRM／D．


NOTES：
1．DIMENSIONS ARE IN MILLIMETERS．
2．INTERPRET DIMENSIONS AND TOLERANCES
PER ASME Y14．5M， 1994
3．DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION
4．MAXIMUM MOLD PROTRUSION 0.15 PER SIDE
5．DIMENSION B DOES NOT INCLUDE DAMBAR
PROTRUSION．ALLOWABLE PROTRUSION
PROTRUSION．ALLOWABLE PROTRUSIO
SHALL BE 0.13 TOTAL IN EXCESS OF B
SHALL BE 0．13 TOTAL IN EXCESS OF B
DIMENSION AT MAXIMUM MATERIAL
DIMENSION AT MAXIMUM MATERIAL
CONDITION．

| DIM | MILLIMETERS |  |
| :---: | :---: | :---: |
|  | MIN | MAX |
| A | 2.35 | 2.65 |
| A1 | 0.10 | 0.25 |
| b | 0.35 | 0.49 |
| c | 0.23 | 0.32 |
| D | 12.65 | 12.95 |
| E | 7.40 | 7.60 |
| e | 1.27 BSC |  |
| H | 10.05 | 10.55 |
| h | 0.25 | 0.75 |
| L | 0.50 | 0.90 |
| 0 | $0^{\circ}$ | $7^{\circ}$ |

## GENERIC <br> MARKING DIAGRAM＊ <br> 20日月日日月日日月日 <br> 

XXXXX＝Specific Device Code
A＝Assembly Location
WL＝Wafer Lot
YY＝Year
WW＝Work Week
$\mathrm{G} \quad=\mathrm{Pb}-$ Free Package
＊This information is generic．Please refer to device data sheet for actual part marking． $\mathrm{Pb}-$ Free indicator，＂ G ＂or microdot＂$\stackrel{ }{ }$＂， may or may not be present．

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| ---: | :--- | :--- | :--- |
| DESCRIPTION： | SOIC－20 WB | PAGE 1 OF 1 |

[^2]TSSOP-20 WB
CASE 948E
ISSUE D
DATE 17 FEB 2016

SCALE 2:1


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
CONTROLLING DIMENSION: MILLIMETER
2. DIMENSION A DOES NOT INCLUDE MOLD

FLASH, PROTRUSIONS OR GATE BURRS.
MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION INTERLEAD FLASH OR PROTRUSION. SHALL NOT EXCEED 0.25 (0.010) PER SIDE
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W

| DIM | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 6.40 | 6.60 | 0.252 | 0.260 |
| B | 4.30 | 4.50 | 0.169 | 0.177 |
| C | --- | 1.20 | --- | 0.047 |
| D | 0.05 | 0.15 | 0.002 | 0.006 |
| F | 0.50 | 0.75 | 0.020 | 0.030 |
| G | 0.65 BSC |  | 0.026 BSC |  |
| H | 0.27 | 0.3 | 0.011 | 0.015 |
| J | 0.09 | 0.20 | 0.004 | 0.008 |
| J1 | 0.09 | 0.16 | 0.004 | 0.006 |
| K | 0.19 | 0.30 | 0.007 | 0.012 |
| K1 | 0.19 | 0.25 | 0.007 | 0.010 |
| L | 6.40 BSC |  | 0.252 BSC |  |
| M | $0^{\circ}$ | $8^{\circ}$ | $0^{\circ}$ | $8^{\circ}$ |

GENERIC MARKING DIAGRAM*




A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week

- = Pb-Free Package
(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-$ Free indicator, "G" or microdot " $\quad$ ", may or may not be present.

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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | TSSOP-20 WB | PAGE 1 OF 1 |

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[^0]:    *For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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